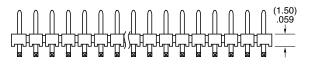
LOW-PROFILE SMT HEADER

(2.00 mm) .0787" PITCH • TMM SERIES

тмм NO. PINS PER ROW LEAD ROW PLATING OTHER 1 тмм SM **Board Mates:** STYLE OPTION OPTION OPTION CLT, SQT, SQW, ESQT, TLE, SMM, MMS Specify LEAD -S 02 thru 40 -F -A **Cable Mates:** = Gold flash Single Alignment Pin TCSD STYLE on post, Matte Tin on tail Row (Metal or plastic at Samtec's from discretion) -D chart **SPECIFICATIONS** (5 positions minimum) -L Double = = 10 μ" (0.25 μm) Gold on post, Row (-D only) Insulator Material: Black Liquid Crystal Polymer Terminal Material: Matte Tin on tail -"XXX" = Polarized Position Phosphor Bronze **--S** = 30 μ" (0.76 μm) Plating: Sn or Au over 50 μ" (1.27 μm) Ni **Current Rating:** (Specify Gold on post, position of omitted pin) Matte Tin on tail (2 pins powered) **Operating Temp Range:** $-55 \degree C to +105 \degree C with Tin;$ $<math>-55 \degree C to +125 \degree C with Gold$ -T -P = Matte Tin = Pick & Place Pad (3 positions Voltage Rating: 281 VAC mated with SQW; 250 VAC mated with SQT minimum) -TR = Tape & Reel (3 thru 36 PROCESSING positions only) Lead-Free Solderable: **-FR** = Full Reel Tape & Reel SMT Lead Coplanarity: (0.15 mm) .006" max* *(.004" stencil solution (must order max. quantity per reel; contact may be available; contact IPG@samtec.com) Samtec for quantity breaks) (3 thru 36 (1.97) .078 No. of positions x (2.00) .0787 positions only) |o||o||o||o||o||o| ALSO AVAILABLE Other plating -P (MOQ Required) LEAD STYLE MATES WITH A SQT, SQW, ESQT, -01 (3.20) .126 FLE, SMM, MMS, TCSD -04 (1.91) .075 CLT -05 (1.65) .065

8 Gbp





Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.

-06

(7.06)

.278

-D

Α

(4.27) .168

CLT-BE

(4.83)

190

-S

Some lengths, styles and options are non-standard, non-returnable.

ENDED LIFE

ODUC HIGH MATING CYCLES